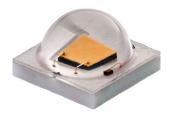
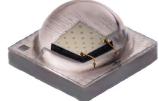
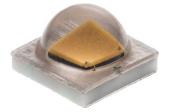
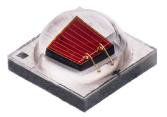


Cree® XLamp® XP-E2 LEDs









PRODUCT DESCRIPTION

The XLamp® XP-E2 LED builds on the unprecedented performance of the original XP-E by increasing lumen output up to 20% while providing a single die LED point source for precise optical control. The XP-E2 LED shares the same footprint as the original XP-E, providing a seamless upgrade path to more lumens and/or greater efficiency while shortening the design cycle for existing XP customers.

XLamp XP-E2 LEDs are the ideal choice for lighting applications where high light output and maximum efficacy are required, such as LED retrofit lamps, outdoor, portable, indoor directional, emergency vehicle or architectural.

FEATURES

- Available in white, outdoor white, 80-CRI, 85-CRI, 90-CRI white, royal blue, blue, green, PC amber, amber, red-orange & red
- · ANSI-compatible chromaticity bins
- White binned at 85 °C
- · Maximum drive current: 1 A
- Low thermal resistance: as low as 5 °C/W
- Wide viewing angle: 110°-135°
- Unlimited floor life at
 ≤ 30 °C/85% RH
- Reflow solderable JEDEC J-STD-020C compatible
- · Electrically neutral thermal path
- RoHS- and REACh-compliant
- UL® recognized component (E349212)



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CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white, royal blue, blue	°C/W		9	
Thermal resistance, junction to solder point - green	°C/W		15	
Thermal resistance, junction to solder point - PC amber	°C/W		9	
Thermal resistance, junction to solder point - amber	°C/W		7	
Thermal resistance, junction to solder point - red-orange, red	°C/W		5	
Viewing angle (FWHM) - white	degrees		110	
Viewing angle (FWHM) - royal blue, blue, green	degrees		135	
Viewing angle (FWHM) - PC amber	degrees		110	
Viewing angle (FWHM) - amber, red-orange, red	degrees		130	
Temperature coefficient of voltage - white	mV/°C		-2.3	
Temperature coefficient of voltage - royal blue, blue	mV/°C		-3.3	
Temperature coefficient of voltage - green	mV/°C		-3.8	
Temperature coefficient of voltage - PC amber	mV/°C		-2.5	
Temperature coefficient of voltage - amber, red-orange, red	mV/°C		-1.8	
ESD withstand voltage (HBM per Mil-Std-883D)- white, royal blue, blue, green	V			8000
ESD classification (HBM per Mil-Std-883D) - PC amber, amber, red-orange, red			Class 2	
DC forward current	mA			1000
Reverse voltage	V			5
Forward voltage (@ 350 mA, 85 °C) - white	V		2.9	3.25
Forward voltage (@ 700 mA, 85 °C) - white			3.05	
Forward voltage (@ 1000 mA, 85 °C) - white			3.15	
Forward voltage (@ 350 mA, 25 °C) - royal blue, blue	V		3.1	3.5
Forward voltage (@ 1000 mA, 25 °C) - royal blue, blue	V		3.4	
Forward voltage (@ 350 mA, 25 °C) - green	V		3.2	3.8
Forward voltage (@ 1000 mA, 25 °C) - green	V		3.7	
Forward voltage (@ 350 mA, 25 °C) - PC amber	V		3.05	3.5
Forward voltage (@ 1000 mA, 25 °C) - PC amber	V		3.28	
Forward voltage (@ 350 mA, 25 °C) - amber, red-orange, red	V		2.2	2.6
Forward voltage (@ 1000 mA, 25 °C) - amber, red-orange, red	V		2.65	
LED junction temperature	°C			150



FLUX CHARACTERISTICS (T, = 85 °C) - WHITE

The following table provides several base order codes for XLamp XP-E2 LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP Family LEDs Binning and Labeling document.

Color	сст	Range	Minimu	ım Luminous Fl @ 350 mA	Luminous Flux (lm) മു 350 mA		l Minimum Flux (lm)** 5 °C	Order Code
	Min.	Max.	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	700 mA	1.0 A	
			Q4	100	116	171	218	XPEBWT-L1-0000-00C51
			Q5	107	124	183	233	XPEBWT-L1-0000-00D51
Cool White	5000 K	10,000 K	R2	114	132	195	249	XPEBWT-L1-0000-00E51
			R3	122	142	209	266	XPEBWT-L1-0000-00F51
			R4	130	152	223	284	XPEBWT-L1-0000-00G51
			Q4	100	116	171	218	XPEBWT-01-0000-00CE3
Outdoor	4000 K	5300 K	Q5	107	124	183	233	XPEBWT-01-0000-00DE3
White	4000 K	3300 K	R2	114	132	195	249	XPEBWT-01-0000-00EE3
			R3	122	142	209	266	XPEBWT-01-0000-00FE3
			Q4	100	116	171	218	XPEBWT-L1-0000-00CE4
Neutral White	3700 K	5300 K	Q5	107	124	183	233	XPEBWT-L1-0000-00DE4
			R2	114	132	195	249	XPEBWT-L1-0000-00EE4
80-CRI	2200 K	4300 K	Q2	87.4	101	150	191	XPEBWT-H1-0000-00AE7
White	2200 K	4300 K	Q3	93.9	109	161	205	XPEBWT-H1-0000-00BE7
			Q2	87.4	101	150	191	XPEBWT-L1-0000-00AE7
Warm White	2200 K	3700 K	Q3	93.9	109	161	205	XPEBWT-L1-0000-00BE7
			Q4	100	116	171	218	XPEBWT-L1-0000-00CE7
			P2	67.2	78.0	115	147	XPEBWT-P1-0000-007E7
85-CRI	060016	0000 1/	P3	73.9	85.7	127	161	XPEBWT-P1-0000-008E7
White	2600 K	3200 K	P4	80.6	93.5	138	176	XPEBWT-P1-0000-009E7
			Q2	87.4	101	150	191	XPEBWT-P1-0000-00AE7
			P2	67.2	78.0	115	147	XPEBWT-U1-0000-007E7
90-CRI White	2600 K	3200 K	P3	73.9	85.7	127	161	XPEBWT-U1-0000-008E7
			P4	80.6	93.5	138	176	XPEBWT-U1-0000-009E7

Notes:

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 14).
- Typical CRI for Cool White (5000 K 10,000 K CCT) is 70.
- Typical CRI for Neutral White (3700 K 5300 K CCT) is 75.
- Typical CRI for Outdoor White (4000 K 5300 K CCT) is 70.
- Typical CRI for Warm White (2200 K 3700 K CCT) is 80.
- Minimum CRI for 80-CRI White is 80.
- Minimum CRI for 85-CRI White is 85.
- Minimum CRI for 90-CRI White is 90.
- * Flux values @ 25 °C are calculated and for reference only.
- ** Calculated flux values at 700 mA and 1 A are for reference only.



FLUX CHARACTERISTICS ($T_J = 25 \, ^{\circ}\text{C}$) - COLOR

The following tables provide several base order codes for XLamp XP-E2 color LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP Family LEDs Binning and Labeling document.

		Minimum Radiant Flux @ 350 mA		minant Wav	elength Rai	nge	
Color		Flux	М	in.	M	ах.	Order Codes,
	Group	(mW)	Group	DWL (nm)	Group	DWL (nm)	
	30	450	D3	450	D5	465	XPEBRY-L1-0000-00J01
	31	475	D3	450	D5	465	XPEBRY-L1-0000-00K01
	32	500	D3	450	D5	465	XPEBRY-L1-0000-00L01
Royal	33	525	D3	450	D5	465	XPEBRY-L1-0000-00M01
Blue	34	550	D3	450	D5	465	XPEBRY-L1-0000-00N01
	35	575	D3	450	D5	465	XPEBRY-L1-0000-00P01
	36	600	D3	450	D5	465	XPEBRY-L1-0000-00Q01
	37	625	D3	450	D5	465	XPEBRY-L1-0000-00R01

	Do	minant Wav	elength Ran	ange Minimum Luminous		Luminous				
Color	М	Min. Max. Flux (lm) @ 350 mA		Max.		@ 350 mA	Order Code			
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)				
								K2	30.6	XPEBBL-L1-0000-00Y01
Blue	В3	465	D.C	B6	485	K3	35.2	XPEBBL-L1-0000-00Z01		
blue	ВЭ	405	ВО	403	M2	39.8	XPEBBL-L1-0000-00201			
							M3	45.7	XPEBBL-L1-0000-00301	

	Dominant Wavelength Range				Minimum	Luminous											
Color	M	in.	Ma	ax.	Flux (lm)	@ 350 mA	Order Code										
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)											
					Q2	87.4	XPEBGR-L1-0000-00A01										
					Q3	93.9	XPEBGR-L1-0000-00B01										
				G4	G4			G4 535	G4 535							Q4	100
Green	G2	520	520			G4	G4			Q5	107	XPEBGR-L1-0000-00D01					
			R2								114	XPEBGR-L1-0000-00E01					
					R3	122	XPEBGR-L1-0000-00F01										
					R4	130	XPEBGR-L1-0000-00G01										

Note

Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements.



FLUX CHARACTERISTICS (T_J = 25 °C) - COLOR (CONTINUED)

Color	Color Bin		ıminous Flux 350 mA	Order Code
		Group	Flux (lm)	
		Q2	87.4	XPEBPA-L1-0000-00A01
DC Ambar	Y2	Q3	93.9	XPEBPA-L1-0000-00B01
PC Amber	¥Z	Q4	100	XPEBPA-L1-0000-00C01
		Q5	107	XPEBPA-L1-0000-00D01

	Dominant Wavelength Range					Luminous						
Color	Min.		Ma			@ 350 mA	Order Code					
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)						
				F0F A0		N4	62.0	XPEBAM-L1-0000-00601				
Amber	A2	585	4.0		4.2	۸۵	A 2	A3	A 2	EOF	P2	67.2
Amber	AZ	383	A3	A3 595	P3	73.9	XPEBAM-L1-0000-00801					
						P4	80.6	XPEBAM-L1-0000-00901				

	Dominant Wavelength Range				Minimum	Luminous				
Color	Mi	in.	Max.		Flux (lm) @ 350 mA		Order Code			
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)				
					P2	67.2	XPEBRO-L1-0000-00701			
			04 620		P3	73.9	XPEBRO-L1-0000-00801			
				04	04 620	04		P4	80.6	XPEBRO-L1-0000-00901
Red- Orange	03	610					04	04	620	620
							Q3	93.9	XPEBRO-L1-0000-00B01	
					Q4 100	XPEBRO-L1-0000-00C01				
									Q5	107

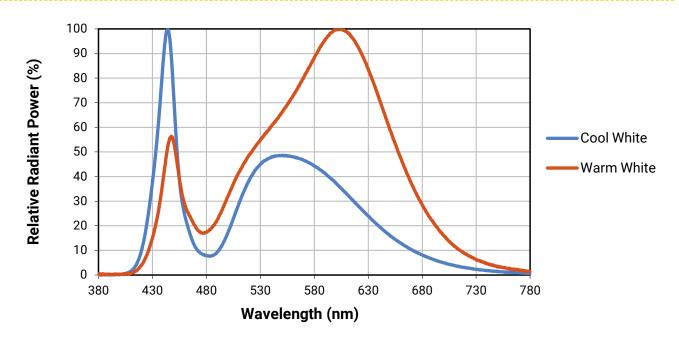
	Do	minant Wav	elength Rar	nge	Minimum	Luminous							
Color	М	in.	Max.		Flux (lm) @ 350 mA		Order Code						
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)							
			R3	R3 630	R3		N3 56	56.8	XPEBRD-L1-0000-00501				
						R3	R3	R3	R3 630		N4	62.0	XPEBRD-L1-0000-00601
Red	R2	620								P2	67.2	XPEBRD-L1-0000-00701	
					P3	73.9	XPEBRD-L1-0000-00801						
					P4	80.6	XPEBRD-L1-0000-00901						

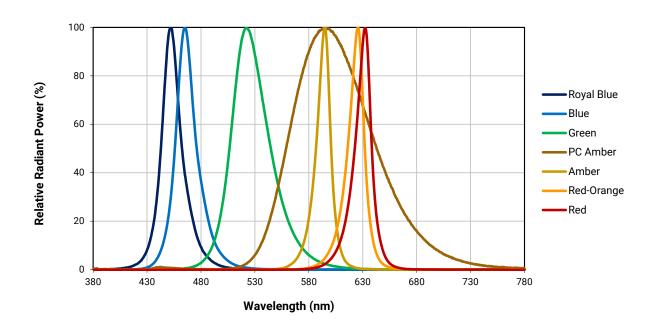
Note:

• Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements.



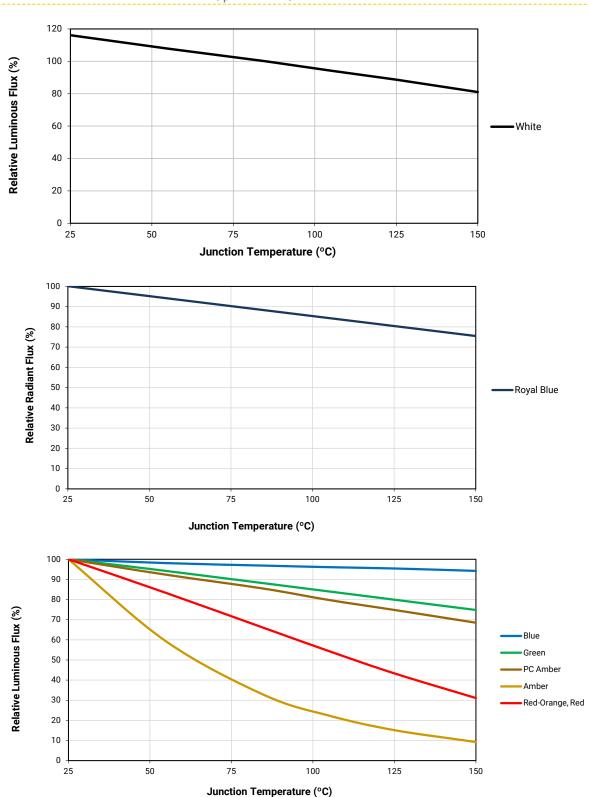
RELATIVE SPECTRAL POWER DISTRIBUTION





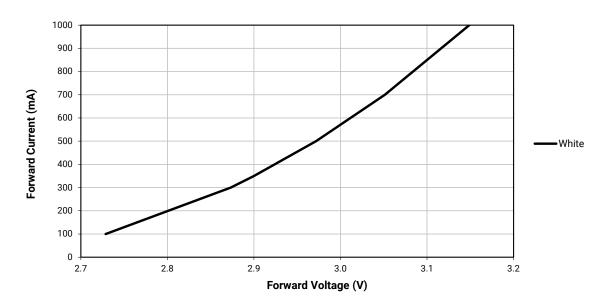


RELATIVE FLUX VS. JUNCTION TEMPERATURE (I_F = 350 mA)

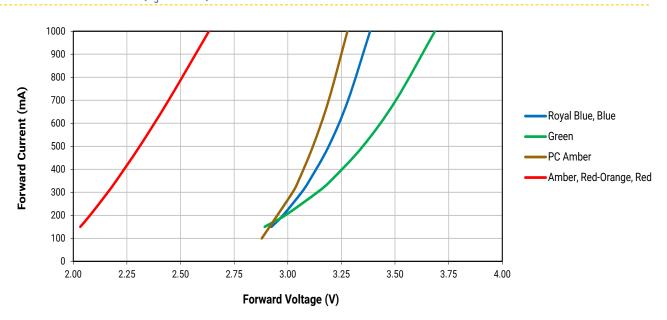




ELECTRICAL CHARACTERISTICS (T, = 85 °C) - WHITE

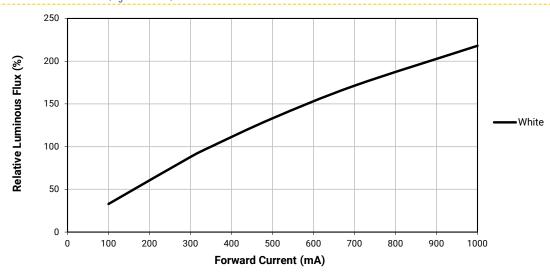


ELECTRICAL CHARACTERISTICS (T, = 25 °C) - COLOR

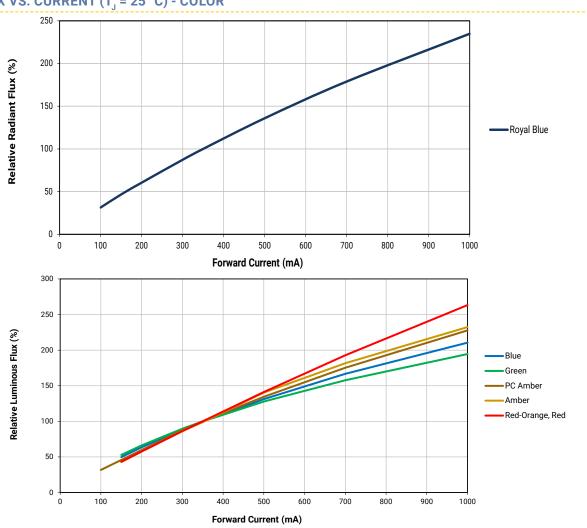




RELATIVE FLUX VS. CURRENT ($T_J = 85 \, ^{\circ}\text{C}$) - WHITE

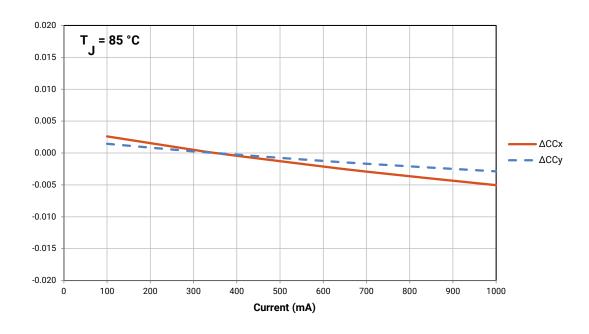


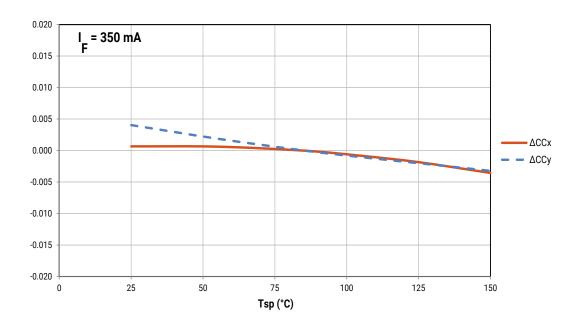
RELATIVE FLUX VS. CURRENT (T₁ = 25 °C) - COLOR





RELATIVE CHROMATICITY VS. CURRENT AND TEMPERATURE - WARM WHITE*

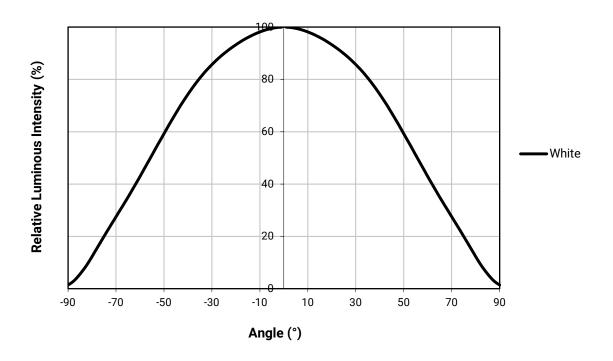


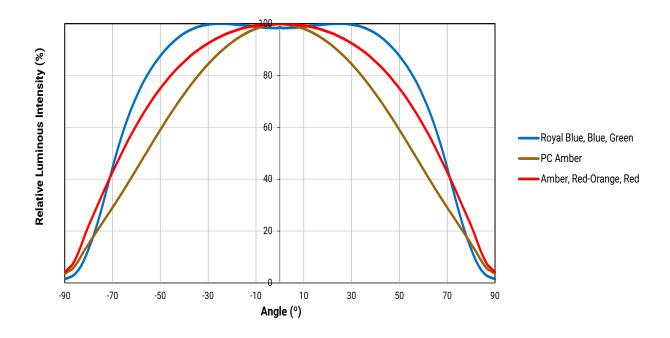


^{*} Warm White XLamp XP-E2 LEDs have a typical CRI of 80.



TYPICAL SPATIAL DISTRIBUTION

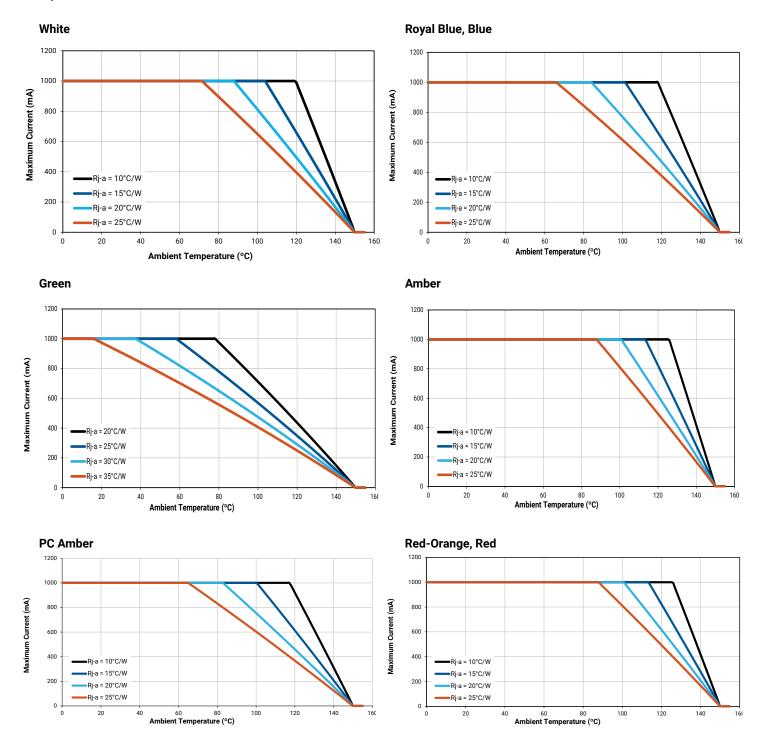






THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

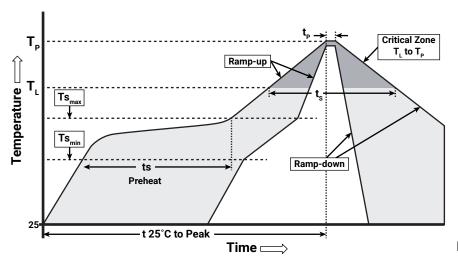




REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XP-E2 LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	1.2 °C/second
Preheat: Temperature Min (Ts _{min})	120 °C
Preheat: Temperature Max (Ts _{max})	170 °C
Preheat: Time (ts _{min} to ts _{max})	65-150 seconds
Time Maintained Above: Temperature (T _L)	217 °C
Time Maintained Above: Time (t _L)	45-90 seconds
Peak/Classification Temperature (Tp)	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



NOTES

Measurements

The luminous flux, radiant power, chromaticity and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

Pre-Release Qualification Testing

Please read the LED Reliability Overview for details of the qualification process Cree applies to ensure long-term reliability for XLamp LEDs and details of Cree's pre-release qualification testing for XLamp LEDs.

Lumen Maintenance

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

Cree recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XP-E2 LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of \leq 30 °C/85% relative humidity (RH). Regardless of the storage condition, Cree recommends sealing any unsoldered LEDs in the original MBP.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

REACh Compliance

REACh substances of very high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.



NOTES - CONTINUED

UL® Recognized Component

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/ UL 8750.

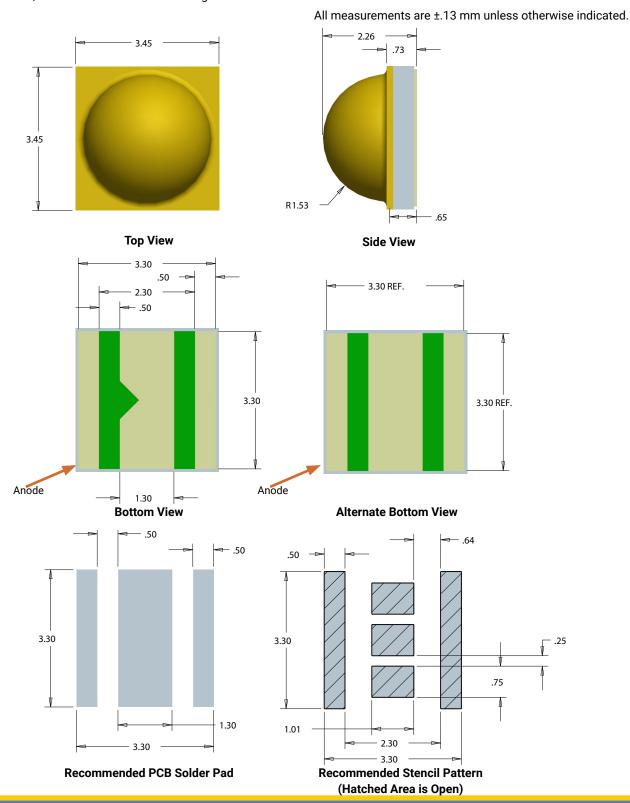
Vision Advisory

WARNING: Do not look at exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.



MECHANICAL DIMENSIONS

Thermal vias, if present, are not shown on these drawings.



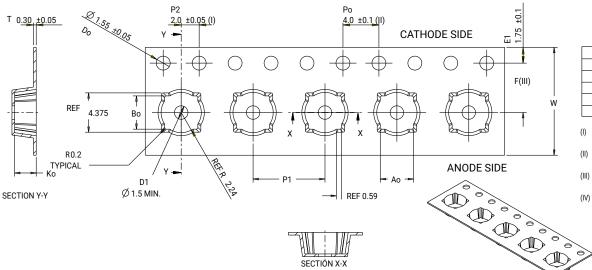


TAPE AND REEL

END

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

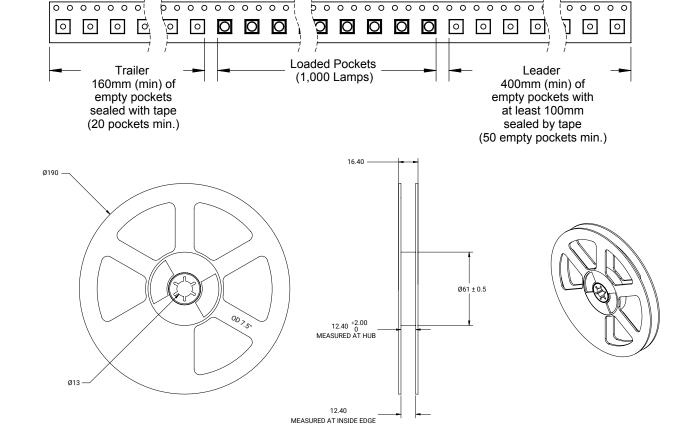
All dimensions in mm.



Ao	3.70	+/- 0.1
Во	3.70	+/- 0.1
Ko	2.40	+0.0/-0.1
F	5.50	+/- 0.05
P 1	8.00	+/- 0.1
W	12.00	±0.3/-0.1

- Measured from centerline of sprocket hole to centerline of pocket.
- (II) Cumulative tolerance of 10 sprocket holes is ± 0.20.
- (III) Measured from centerline of sprocket hole to centerline of pocket.
- (IV) Other material available.

START





PACKAGING

